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OKI Semiconductor

This version: Aug. 1998
Previous version: Nov. 1996

MSM7705-01/02/03

4ch Single Rail CODEC

GENERAL DESCRIPTION

The MSM7705-01/02/03 are four-channel CODEC CMOS ICs for voice signals ranging from 300 to 3400 Hz. These devices contain filters for A/D and D/A conversion.

Designed especially for a single-power supply and low-power applications, these devices contain four-channel A/D and D/A converters in a single chip and achieve a reduced footprint and a reduced number of external components.

The MSM7705-01/02/03 are best suited for digital telephone terminals, digital PABXs, and pushbutton phones.

FEATURES

- Single power supply: +5 V
- Power consumption

Operating mode: 70 mW Typ. 140 mW Max. Power-saving mode: 14 mW Typ. 32 mW Max. Power-down mode: 0.05 mW Typ. 0.3 mW Max.

Conforms to ITU-T Companding law

MSM7705-01: μ /A-law pin-selectable

MSM7705-02: μ-law MSM7705-03: A-law

- Built-in PLL eliminates a master clock
- The PCM interface can be switched between 4 channel serial/parallel
- Transmission clock: 64/128/256/512/1024/2048 kHz

96/192/384/768/1536/1544 kHz

(During 4 channel serial mode, the 64, 96, 128, and 192 kHz clocks are

disabled)

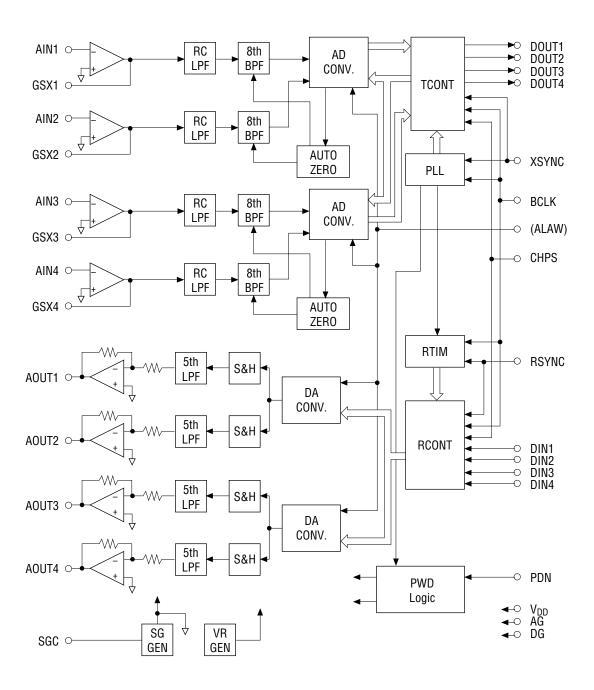
- Transmit gain adjustable for each channel
- Built-in reference voltage supply
- Analog output can directly drive a 600 Ω line transformer
- Package:

44-pin plastic QFP (QFP44-P-910-0.80-2K) (Product name: MSM7705-01GS-2K)

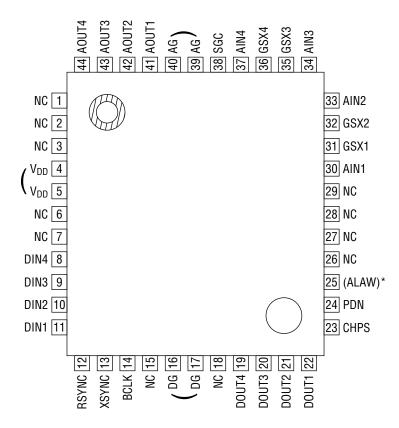
(Product name: MSM7705-02GS-2K) (Product name: MSM7705-03GS-2K)



BLOCK DIAGRAM



PIN CONFIGURATION (TOP VIEW)



NC : No connect pin

44-Pin Plastic QFP

 $\ensuremath{V_{DD}}\xspace$, DG, and AG have two pins each. Each of these pairs are internally connected with each other.

^{*} The ALAW pin is only supported by MSM7705-01GS-2K.

PIN AND FUNCTIONAL DESCRIPTIONS

AIN1, AIN2, AIN3, AIN4, GSX1, GSX2, GSX3, GSX4

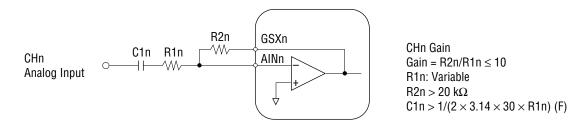
AIN1, AIN2, AIN3, and AIN4 are the transmit analog inputs for channels 1, 2, 3 and 4 respectively.

GSX1, GSX2, GSX3, and GSX4 are the transmit level adjustments for channels 1, 2, 3 and 4 respectively.

AIN1, AIN2, AIN3, and AIN4 are connected to the inverting inputs for the op-amps. GSX1, GSX2, GSX3, and GSX4 are connected to the outputs for the op-amps. They are used to adjust levels as shown below, and are connected to the outputs of the op-amps.

During power saving mode and power down mode, the GSX1, GSX2, GSX3, and GSX4 outputs are at 0 V.

When these pins are not used, connect AIN1 to GSX1, AIN2 to GSX2, AIN3 to GSX3, and AIN4 to GSX4.



AOUT1, AOUT2, AOUT3, AOUT4

AOUT1, AOUT2, AOUT3, and AOUT4 are the receive filter outputs for channels 1, 2, 3, and 4 respectively.

When the digital signal of +3 dBm0 is input to DIN1, DIN2, DIN3, and DIN4, the output signal has an amplitude of 3.4 V_{PP} above and below the signal ground voltage (SG : 1/2 V_{DD}). The output can drive a load of 600 Ω or more.

During power saving or power down mode, these outputs are at the voltage level of SG with a high impedance.

DIN1, DIN2, DIN3

PCM signal inputs for channels 1, 2, and 3 when the parallel mode is selected.

D/A conversion is performed by the serial PCM signals to these pins, the RSYNC signals synchronous with the serial PCM signals, and the BCLK signal. Then the analog signals are output from AOUT1, AOUT2, and AOUT3 pins, respectively.

The data rate of the PCM signal is equal to the frequency of the BCLK signal.

The PCM signal is shifted at the falling edge of the BCLK signal and latched into the internal register when shifted by eight bits.

The start of the PCM data (MSD) is identified at the rising edge of RSYNC.

When the serial mode is selected, this pin is not used and should be connected to GND (0 V).

DIN4

PCM signal input for channel 4 when the parallel mode is selected.

D/A conversion is performed by the serial PCM signal to this pin, the RSYNC signal synchronous with the serial PCM signal, and the BCLK signal. Then the analog signal is output from AOUT4 pin.

The data rate of the PCM signal is equal to the frequency of the BCLK signal.

The PCM signal is shifted at the falling edge of the BCLK signal and latched into the internal register when shifted by eight bits.

The start of the PCM data (MSD) is identified at the rising edge of RSYNC.

When the serial mode is selected, this pin is used for the 4ch multiplexed PCM signal input.

BCLK

Shift clock signal input for DIN1, DIN2, DIN3, DIN4, DOUT1, DOUT2, DOUT3, and DOUT4. The frequency is equal to the data rate. Setting this signal to logic "1" or "0" drives both transmit and receive circuits to the power saving state.

RSYNC

Receive synchronizing signal input.

Eight bits of PCM data required are selected from a series of PCM signal to the DIN1, DIN2, DIN3, and DIN4 pins by the receive synchronizing signal.

All timing signals in the receive section are synchronized by this synchronizing signal. This signal must be synchronized in phase with the BCLK (generated from the same clock source as BCLK). The frequency should be $8~\rm kHz\,\pm50$ ppm to guarantee the AC characteristics which are mainly the frequency characteristics of the receive section.

However, this device operates in the range of 6 kHz to 10 kHz unless the frequency characteristics of the system used are strictly specified, but the electrical characteristics specified in the data sheet are not guaranteed.

XSYNC

Transmit synchronizing signal input.

PCM output signal from the DOUT1, DOUT2, DOUT3, and DOUT4 pins is output in synchronization with this transmit synchronizing signal. This synchronizing signal triggers the PLL and synchronizes all timing signals of the transmit section.

This synchronizing signal must be synchronized in phase with BCLK.

The frequency should be $8 \text{ kHz} \pm 50 \text{ ppm}$ to guarantee the AC characteristics which are mainly the frequency characteristics of the transmit section.

However, this device can be operated in the range of 6 kHz to 10 kHz unless the frequency characteristics of the system used are strictly specified, but the electrical characteristics are not guaranteed.

Setting this signal to logic "1" or "0" drives both transmit and receive circuits to power saving state.

DOUT1

PCM signal output of channel 1 when the parallel mode is selected.

The PCM output signal is output from MSD in a sequential order, synchronizing with the rising edge of the BCLK signal.

MSD may be output at the rising edge of the XSYNC signal, based on the timing between BCLK and XSYNC.

This pin is in a high impedance state except during 8-bit PCM output. It is also in a high impedance state during power-saving state or power-down state.

When the serial mode is selected, this pin is configured to be the output of serial multiplexed 4ch PCM signal.

A pull-up resistor must be connected to this pin because it is an open drain output.

This device is compatible with the ITU-T recommendation on coding law and output coding format.

The MSM7705-03 (A-law) outputs the character signal, inverting the even bits.

| Imput/Output Laval | PCMIN/PCMOUT | | | | | | | | |
|--------------------|--------------------|--------------------|--|--|--|--|--|--|--|
| Input/Output Level | MSM7705-02 (μ-law) | MSM7705-03 (A-law) | | | | | | | |
| | MSD | MSD | | | | | | | |
| +Full scale | 1 0 0 0 0 0 0 0 | 1 0 1 0 1 0 1 0 | | | | | | | |
| +0 | 1 1 1 1 1 1 1 1 | 1 1 0 1 0 1 0 1 | | | | | | | |
| -0 | 0 1 1 1 1 1 1 1 | 0 1 0 1 0 1 0 1 | | | | | | | |
| –Full scale | 0 0 0 0 0 0 0 0 | 0 0 1 0 1 0 1 0 | | | | | | | |

DOUT2, DOUT3, DOUT4

PCM signal outputs for channels 2, 3, and 4 when parallel mode is selected.

The PCM output signal is output from MSD in a sequential order, synchronizing with the rising edge of the BCLK signal.

MSD may be output at the rising edge of the XSYNC signal, based on the timing between BCLK and XSYNC.

This pin is in a high impedance state except during 8-bit PCM output. It is also in a high impedance state during power-saving state or power-down state.

When the serial mode is selected, this pin is unconnected.

A pull-up resistor must be connected to each of these pins because it is an open drain output. This device is compatible with the ITU-T recommendation on coding law and output coding format.

The MSM7705-03 (A-law) outputs the character signal inverting the even bits.

CHPS

Control signal input for the mode selection of PCM input and output.

When this signal is at a logic "1" level, the PCM input and output are in parallel mode. The PCM data of CH1, CH2, CH3, and CH4 is input to DIN1, DIN2, DIN3, and DIN4 outputs from DOUT1, DOUT2, DOUT3, and DOUT4 with the same timing.

When this signal is at logic "0" level, the PCM input and output are in serial mode. The PCM data of CH1 to CH4 is input from DIN4 and output from DOUT1 as time division multiplexed data.

PDN

Power down control signal.

When PDN is at a logic "0" level, both transmit and receive circuits are in power down state.

V_{DD}

Power supply for +5 V.

A power supply for an analog circuit in the system to which the device is applied should be used. A bypass capacitor of $0.1\,\mu\text{F}$ to $1\,\mu\text{F}$ with excellent high-frequency characteristics and a capacitor of $10\,\mu\text{F}$ to $20\,\mu\text{F}$ should be connected between this pin and the AG pin if needed.

AG

Analog signal ground.

DG

Ground for digital signal circuits.

This ground is separate from the analog signal ground. The DG pin must be connected to the AG pin on the printed circuit board to make a common analog ground.

SGC

Used to generate the signal ground voltage level by connecting a bypass capacitor. Connect a $0.1\,\mu F$ capacitor with excellent high frequency characteristics between the AG pin and the SGC pin.

ALAW

Control signal input of the companding law selection.

Only the MSM7705-01GS-2K has this pin. The CODEC will operate in the μ -law when this pin is at a logic "0" level and will operate in the A-law when this pin is at a logic "1" level. The CODEC operates in the μ -law if the pin is left open, since this pin is internally pulled down.

ABSOLUTE MAXIMUM RATINGS

| Parameter | Symbol | Condition | Rating | Unit |
|-----------------------|------------------|-----------|-------------------------------|------|
| Power Supply Voltage | V _{DD} | _ | 0 to 7.0 | V |
| Analog Input Voltage | VAIN | _ | -0.3 to V _{DD} + 0.3 | V |
| Digital Input Voltage | V _{DIN} | _ | -0.3 to V _{DD} + 0.3 | V |
| Storage Temperature | T _{STG} | _ | -55 to +150 | °C |

RECOMMENDED OPERATING CONDITIONS

| Parameter | Symbol | Condition | Min. | Тур. | Max. | Unit |
|----------------------------------|------------------|---|---------------------------|------------------------|-------------------------|----------|
| Power Supply Voltage | V_{DD} | Voltage must be fixed | 4.75 | 5.0 | 5.25 | V |
| Operating Temperature | Ta | _ | -30 | +25 | +85 | °C |
| Analog Input Voltage | V _{AIN} | Gain = 1 | _ | _ | 3.4 | V_{PP} |
| High Level Input Voltage | V _{IH} | XSYNC, RSYNC, BCLK, DIN DIN2, DIN3, DIN4, PDN, | 1, 2.2 | _ | V _{DD} | V |
| Low Level Input Voltage | V _{IL} | CHPS, ALAW | 0 | _ | 0.8 | V |
| | | BCLK = (When in 4ch serial | 64, 128, | 256, 512, ⁻ | 1024, | |
| Clock Frequency | Fc | mode, 64, 96, 128, 192 kHz | 2048, 96 | , 192, 384, | 768, | kHz |
| | | are not used) | 1536, 15 | 44 | | |
| Sync Pulse Frequency | F _S | XSYNC, RSYNC | 6.0 | 8.0 | 10.0 | kHz |
| Clock Duty Ratio | D _C | BCLK | 40 | 50 | 60 | % |
| Digital Input Rise Time | t _{lr} | XSYNC, RSYNC, BCLK, DIN1 | , – | _ | 50 | ns |
| Digital Input Fall Time | t _{lf} | DIN2, DIN3, DIN4, PDN, CHP | s — | _ | 50 | ns |
| Transmit Sync Pulse Setting Time | t _{XS} | BCLK→XSYNC, See Fig. 1 | 100 | _ | _ | ns |
| Transmit Sync Pulse Setting Time | t _{SX} | XSYNC→BCLK, See Fig. 1 | 100 | _ | _ | ns |
| Pagaina Cuna Dulas Catting Time | t _{RS} | BCLK→RSYNC, See Fig. 1 | 100 | _ | _ | ns |
| Receive Sync Pulse Setting Time | t _{SR} | RSYNC→BCLK, See Fig. 1 | 100 | _ | _ | ns |
| Sync Pulse Width | tws | XSYNC, RSYNC | 1 BCLK | _ | 100 | μS |
| DIN Setup Time | t _{DS} | DIN1, DIN2, DIN3, DIN4 | 100 | _ | _ | ns |
| DIN Hold Time | t _{DH} | DIN1, DIN2, DIN3, DIN4 | 100 | _ | _ | ns |
| Digital Output Load | R _{DL} | DOUT1, DOUT2, Pull-up resist | or 0.5 | _ | _ | kΩ |
| Digital Output Load | C _{DL} | DOUT3, DOUT4 — | _ | _ | 100 | pF |
| Analog Input Allowable DC Offset | W | Transmit gain stage, Gain = | 1 V _{DD} /2 –100 | _ | V _{DD} /2 +100 | mV |
| Analog Input Allowable DC Offset | V _{off} | Transmit gain stage, Gain = 1 | 0 V _{DD} /2 –10 | _ | V _{DD} /2 +10 | mV |
| Allowable Jitter Width | _ | XSYNC, RSYNC | _ | _ | 500 | ns |

ELECTRICAL CHARACTERISTICS

DC and Digital Interface Characteristics

 $(V_{DD} = +5 \text{ V } \pm 5\%, \text{ Ta} = -30^{\circ}\text{C to } +85^{\circ}\text{C})$

| | | , | | | | |
|----------------------------------|------------------|--|------|------|----------|------|
| Parameter | Symbol | Condition | Min. | Тур. | Max. | Unit |
| | I _{DD1} | Operating mode, No signal | _ | 14.0 | 28.0 | mA |
| Power Supply Current | I _{DD2} | Power-save mode, PDN = 1, XSYNC or BCLK OFF | _ | 2.6 | 6.0 | mA |
| | I _{DD3} | Power-down mode, PDN = 0 BCLK OFF | _ | 0.01 | 0.05 | mA |
| High Level Input Voltage | V _{IH} | _ | 2.2 | | V_{DD} | V |
| Low Level Input Voltage | V _{IL} | _ | 0.0 | _ | 0.8 | V |
| High Level Input Leakage Current | I _{IH} | _ | _ | _ | 2.0 | μΑ |
| Low Level Input Leakage Current | I _{IL} | _ | _ | _ | 0.5 | μΑ |
| Digital Output Low Voltage | V _{OL} | Pull-up resistor $> 500 \Omega$ | 0.0 | 0.2 | 0.4 | V |
| Digital Output Leakage Current | I ₀ | _ | _ | _ | 10 | μА |
| Input Capacitance | CIN | _ | _ | 5 | | pF |

Transmit Analog Interface Characteristics

 $(V_{DD} = +5 \text{ V} \pm 5\%, \text{ Ta} = -30^{\circ}\text{C to} +85^{\circ}\text{C})$

| | | | \ | י טטי | _ 0 / 0 , | 00 0 10 | , |
|-------------------------|-------------------|------------------------|--------------------|-------|-----------|---------|----|
| Parameter | Symbol | Cond | Min. | Тур. | Max. | Unit | |
| Input Resistance | R _{INX} | AIN1, AIN2, AIN | N3, AIN4 | 10 | | _ | MΩ |
| Output Load Resistance | R _{LGX} | GSX1, GSX2, GSX3, GSX4 | | 20 | - | _ | kΩ |
| Output Load Capacitance | C _{LGX} | with respect to | with respect to SG | | - | 30 | pF |
| Output Amplitude | V _{OGX} | | | -1.7 | | +1.7 | V |
| Offset Voltage | V _{OSGX} | | Gain = 1 | -20 | | +20 | mV |

Receive Analog Interface Characteristics

| Parameter | Symbol | Condition | | Min. | Тур. | Max. | Unit |
|-------------------------|-------------------|-----------|------------------------------|------|------|------|------|
| Output Load Pagistance | р. | | Each output; | 0.6 | | | kΩ |
| Output Load Resistance | R _{LAO} | AOUT1 | with respect to SG | 0.0 | _ | | KS2 |
| Output Load Capacitance | C _{LAO} | AOUT2 | _ | _ | _ | 50 | pF |
| Output Amplitude | V | AOUT3 | $R_L = 0.6 \text{ k}\Omega;$ | 17 | | +1.7 | V |
| Output Amplitude | V _{OAO} | AOUT4 | with respect to SG | -1.7 | _ | +1.7 | \ |
| Offset Voltage | V _{OSAO} | | _ | -100 | _ | +100 | mV |

AC Characteristics

| | | | | | | $(V_{DD} = +5 \text{ V } \pm 5\%, \text{ Ia} = -30^{\circ}\text{C to } +85^{\circ}\text{C}$ | | | |
|-------------------------------------|---------|---------------|-----------------|-----------|-------|---|-------|------|--|
| Parameter | Symbol | Freq. (Hz) | Level (dBm0) | Condition | Min. | Тур. | Max. | Unit | |
| | Loss T1 | 60 | | | 20 | 26 | _ | | |
| | Loss T2 | 300 | | | -0.15 | +0.07 | +0.20 | | |
| Transmit Fraguency Decrens | Loss T3 | 1020 | | | | Reference | | מא | |
| Transmit Frequency Response | Loss T4 | 2020 | 0 | | -0.15 | -0.04 | +0.20 | dB | |
| | Loss T5 | 3000 | | | -0.15 | +0.03 | +0.20 | | |
| | Loss T6 | 3400 | | | 0 | 0.40 | 0.80 | | |
| | Loss R1 | 300 | | | -0.15 | -0.03 | +0.20 | | |
| | Loss R2 | 1020 | | | | Reference | | | |
| Receive Frequency Response | Loss R3 | 2020 | 0 | | -0.15 | +0.04 | +0.20 | dB | |
| | Loss R4 | 3000 | | | -0.15 | +0.11 | +0.20 | | |
| | Loss R5 | 3400 | | | 0.0 | 0.47 | 0.80 | | |
| | SD T1 | | 3 | | 35 | 43 | _ | dB | |
| | SD T2 | 1020 | 0 | | 35 | 41 | _ | | |
| Transmit Signal to Distortion Ratio | SD T3 | | -30 | *1 | 35 | 38 | _ | | |
| | SD T4 | | -40 | | 29 | 31.5 | _ | | |
| | SD T5 | | -45 | | 24 | 27 | _ | | |
| | SD R1 | | 3 | | 36 | 43 | _ | | |
| | SD R2 | | 0 | | 36 | 41 | _ | dB | |
| Receive Signal to Distortion Ratio | SD R3 | 1020 | -30 | *1 | 36 | 40 | _ | | |
| | SD R4 | | -40 | | 30 | 33.5 | _ | | |
| | SD R5 | | -45 | | 25 | 30 | _ | | |
| | GT T1 | | 3 | | -0.3 | +0.02 | +0.3 | | |
| | GT T2 | | -10 | | | Reference | | | |
| Transmit Gain Tracking | GT T3 | 1020 | -40 | | -0.3 | +0.04 | +0.3 | dB | |
| | GT T4 | | -50 | | -0.5 | +0.15 | +0.5 | | |
| | GT T5 | | -55 | | -1.2 | +0.40 | +1.2 | | |
| | GT R1 | | 3 | | -0.3 | 0.0 | +0.3 | | |
| | GT R2 | | -10 | | | Reference | | | |
| Receive Gain Tracking | GT R3 | 1020 | -40 | | -0.3 | +0.04 | +0.3 | dB | |
| | GT R4 | | -50 | | -0.5 | +0.16 | +0.5 | | |
| | GT R5 | | -55 | | -1.2 | +0.37 | +1.2 | | |

^{*1} Psophometric filter is used

AC Characteristics (Continued)

| | | | | | VDD - +3 V | $\pm 3 / 0$, $1a = -30 + 0.10$ | | +00 () |
|---------------------------------------|--------------------|---------------|-----------------|---------------------------------------|------------|---------------------------------|-------|--------|
| Parameter | Symbol | Freq. (Hz) | Level (dBm0) | Condition | Min. | Тур. | Max. | Unit |
| | | | , | AIN = SG | _ | -73.5 | -70 | |
| Idle Channel Noise | Nidle T | _ | _ | *1 *2 | _ | -71.5 | -68 | dBm0p |
| | Nidle R | _ | _ | *1 *3 | _ | -78 | -75 | |
| Absolute Level (Initial Difference) | AV T | | | $V_{DD} = 5.0 \text{ V}$ Ta = 25°C | 0.821 | 0.850 | 0.880 | Vrms |
| Absolute Level (Illitial billerefice) | AV R | | | 1α – 25 0 | 0.821 | 0.850 | 0.880 | VIIIIS |
| Absolute Level | AV Tt | 1020 | 0 | V _{DD} = 5 V ±5% | -0.2 | _ | +0.2 | dB |
| (Deviation of Temperature and Power) | AV Rt | | | Ta = -30 to +85°C | -0.2 | _ | +0.2 | dB |
| Absolute Delay | t _D | 1020 | 0 | A to A BCLK = 64 kHz | _ | _ | 0.60 | ms |
| | t _{GD} T1 | 500 | | | _ | 0.19 | 0.75 | |
| | t _{GD} T2 | 600 | | | _ | 0.11 | 0.35 | ms |
| Transmit Group Delay | t _{GD} T3 | 1000 | 0 | *4 | _ | 0.02 | 0.125 | |
| | t _{GD} T4 | 2600 | | | _ | 0.05 | 0.125 | |
| | t _{GD} T5 | 2800 |] | | _ | 0.07 | 0.75 |] |
| | t _{GD} R1 | 500 | | | _ | 0.00 | 0.75 | |
| | t _{GD} R2 | 600 | | | _ | 0.00 | 0.35 | 1 |
| Receive Group Delay | t _{GD} R3 | 1000 | 0 | *4 | _ | 0.00 | 0.125 | ms |
| | t _{GD} R4 | 2600 | | | _ | 0.09 | 0.125 | |
| | t _{GD} R5 | 2800 | | | _ | 0.12 | 0.75 | |
| | CR T | | | $TRANS \to RECV$ | 75 | 80 | _ | |
| Crosstalk Attenuation | CR R | 1020 | 0 | $RECV \to TRANS$ | 70 | 76 | _ | dB |
| | CR CH | | | CH to CH | 75 | 80 | _ | |

^{*1} Psophometric filter is used

^{*2} Upper columns are specified for the μ -law, lower for the A-law

^{*3} Input "0" code to PCMIN

^{*4} Minimum value of the group delay distortion

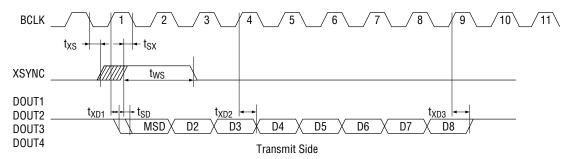
AC Characteristics (Continued)

| | | | | ' | י טטיי | ±0 /0, .u | 00 0 10 | |
|------------------------------------|------------------|----------------------|--|-----------------------|--------|-----------|---------|------|
| Parameter | Symbol | Freq. (Hz) | Level (dBm0) | Condition | Min. | Тур. | Max. | Unit |
| Discrimination | DIS | 4.6 kHz to 72 kHz | 0 | 0 to 4000 Hz | 30 | 32 | _ | dB |
| Out-of-band Spurious | S | 300 to 3400 | 0 | 4.6 kHz to 100 kHz | _ | -37.5 | -35 | dBm0 |
| Intermodulation Distortion | IMD | fa = 470 fd = 320 | -4 | 2fa – fd | _ | -52 | -35 | dBm0 |
| Power Supply Noise Rejection Ratio | PSR T PSR R | 0 to 50 kHz | 50 mV _{PP} | *5 | _ | 30 | _ | dB |
| | t _{SD} | | | | 20 | _ | 200 | |
| Digital Output Delay Time | t _{XD1} | 0 100 - | ъг. 110T | т. | 20 | _ | 200 | |
| | t _{XD2} | OL = 100 | $C_L = 100 \text{ pF} + 1 \text{ LSTTL}$ | | | _ | 200 | ns |
| | t _{XD3} | | | | 20 | | 200 | |

^{*5} Measurement performed under idle channel noise

TIMING DIAGRAM

Transmit Timing



Receive Timing

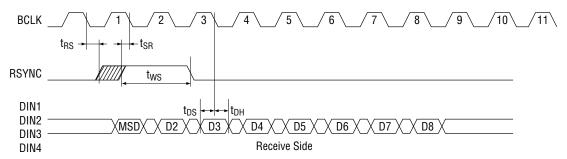


Figure 1 Timing Diagram in the Parallel Mode (CHPS = 1)

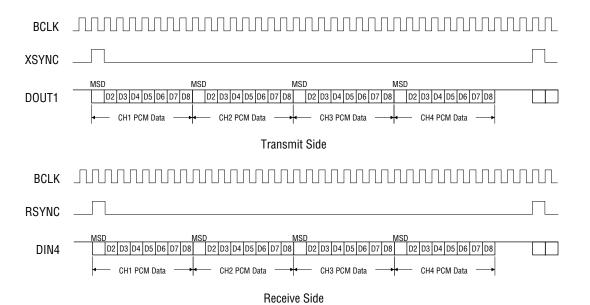
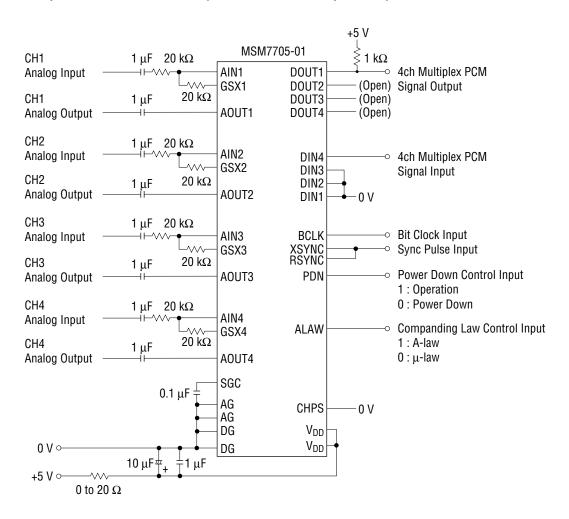


Figure 2 Timing Diagram in the Serial Mode (CHPS = 0)

APPLICATION CIRCUIT

Example of Basic Connection (PCM Serial Mode Operation)



APPLICATION INFORMATION

DOUT Pull-up Resistor

A value of the pull-up resistor for the DOUT pin should be determined depending on frequencies of BCLK and load capacitance.

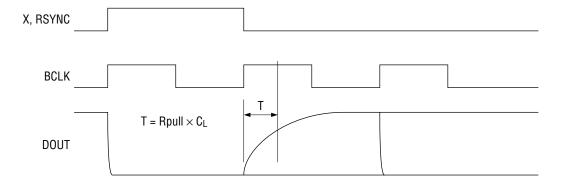
If a smaller value is used, there may be some degradation in noise performance, resulting in an increase in supply current.

Equation to give pull-up resistor

$$|Rpull| = \frac{\frac{1}{4 \times f_{BCLK}} - 50 \text{ ns}}{C_L} \qquad (\Omega) \qquad \text{where} \\ f_{BCLK} = \text{Frequency of BCLK} \\ C_L = \text{Load capacitance of the PCMOUT pin} \\ \text{(approximately 20 pF for a CMOS or TTL load)} \\ 50 \text{ ns} = \text{Internal delay of the MSM7705}$$

Condition for Calculation

If data is turned back from DOUT to DIN under the condition the SYNC signal and BCLK signal rise simultaneously, the data can normally be transferred.



Calculation Example for Typical Values

| DOLK (FIL-) | | Rpull (kΩ) | | | | | | | |
|-------------|------------------------|------------------------|------------------------|-------------------------|--|--|--|--|--|
| BCLK (kHz) | C _L = 10 pF | C _L = 20 pF | C _L = 50 pF | C _L = 100 pF | | | | | |
| 64 | 385.6 | 192.8 | 77.1 | 38.6 | | | | | |
| 128 | 190.3 | 95.2 | 38.1 | 19.0 | | | | | |
| 256 | 92.7 | 46.3 | 18.5 | 9.3 | | | | | |
| 512 | 43.8 | 21.9 | 8.8 | 4.4 | | | | | |
| 1024 | 19.4 | 9.7 | 3.9 | 1.9 | | | | | |
| 1544 | 11.2 | 5.6 | 2.2 | 1.1 | | | | | |
| 2048 | 7.2 | 3.6 | 1.4 | 0.7 | | | | | |

Choice of Actual Resistor Value

If the calculated value is more than or equal to $100~k\Omega$, $100~k\Omega$ should be employed. +10% of the calculated value is within a tolerance, thus, for example, the value of $10~k\Omega$ can be used for the calculated value of $9.3~k\Omega$ in the above examples.

Channel Crosstalk

The MSM7705 contains the 4-channel CODEC. The circuit and trace design and pin layout are made to minimize crosstalk between channels inside the LSI device provided the following should be taken into consideration.

Transmit side

The GSX1 – AIN2, AIN3, and AIN4 traces should not be kept closer.

The GSX2 – AIN1, AIN3, and AIN4 traces should not be kept closer.

The GSX3 – AIN1, AIN2, and AIN4 traces should not be kept closer.

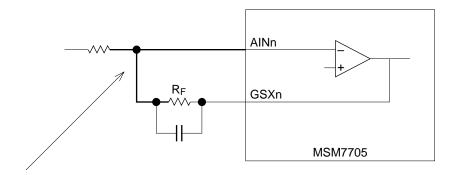
The GSX4 – AIN1, AIN2, and AIN3 traces should not be kept closer.

AIN1, AIN2, AIN3, and AIN4, which are op-amp inverting input pins, have higher resistance, therefore proximity of these lines to signal lines of other channels may cause crosstalk.

Receive side

The channel outputs AOUT1, AOUT2, AOUT3, and AOUT4 of the receive side are amplifier outputs with lower resistance, thus crosstalk due to PCB traces is smaller. Nevertheless, the PCB traces should not be run closer together and in parallel wherever possible.

How to Avoid Transmit Side Amplifier Oscillation Due to PCB Layout



The trace length (illustrated by the bold line in the above drawing) should be kept as short as possible in order to avoid oscillation.

The length of less than 2 cm or 3 cm is permissible, though it depends on PCB layout. It is recommended to connect a capacitor of 20 pF to 50 pF across the feedback resistor R_F , if the oscillation occurs.

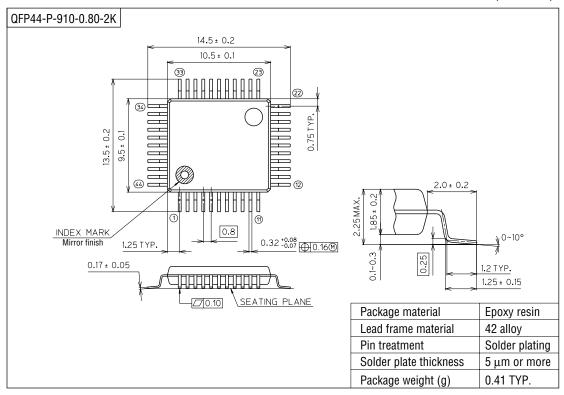
NOTES ON USED

• To ensure proper electrical characteristics, use bypass capacitors with excellent high frequency characteristics for the power supply and keep them as close as possible to the device pins.

- Connect the AG pin and the DG pin as close as possible. Connect to the system ground with low impedance.
- Mount the device directly on the board when mounted on PCBs. Do not use IC sockets. If the use of IC socket is unavoidable, use the short lead type socket.
- When mounted on a frame, use electro-magnetic shielding, if any electro-magnetic wave sources such as power supply transformers surround the device.
- Keep the voltage on the V_{DD} pin not lower than –0.3 V even instantaneously to avoid latchup that may otherwise occur when power is turned on.
- Use a low noise (particularly, low level type of high frequency spike noise or pulse noise) power supply to avoid erroneous operation and the degradation of the characteristics of these devices.

PACKAGE DIMENSIONS

(Unit: mm)



Notes for Mounting the Surface Mount Type Package

The SOP, QFP, TSOP, SOJ, QFJ (PLCC), SHP and BGA are surface mount type packages, which are very susceptible to heat in reflow mounting and humidity absorbed in storage. Therefore, before you perform reflow mounting, contact Oki's responsible sales person for the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).